

## FEATURES

- ESD Protection for RS-232 I/O Pins
  - $\pm 15$  kV (Human-Body Model)
  - $\pm 8$  kV (IEC 61000-4-2, Contact Discharge)
  - $\pm 15$  kV (IEC 61000-4-2, Air-Gap Discharge)
- 300- $\mu$ A Operating Supply Current
- 1- $\mu$ A Low-Power Standby Mode (With Receivers Active)
- Designed to Transmit at a Data Rate of 460 kbps
- Auto-Powerdown Plus Option Features Flexible Power-Saving Mode
- Operates From a Single 2.25-V to 3-V  $V_{CC}$  Supply
- Designed to be Interchangeable With Industry Standard '3318 Devices

## APPLICATIONS

- Battery-Powered Systems
- PDAs
- Cellular Phones
- Notebooks
- Hand-Held Equipment
- Pagers

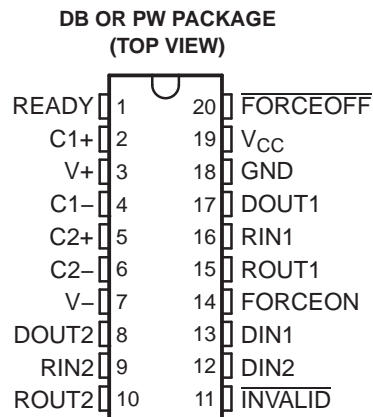
## DESCRIPTION/ORDERING INFORMATION

The TRS3318E is a dual-driver, dual-receiver, RS-232-compatible transceiver. The device features auto-powerdown plus and enhanced electrostatic discharge (ESD) protection integrated into the chip. Driver output and receiver input are protected to  $\pm 15$  kV using the IEC 61000-4-2 Air-Gap Discharge method,  $\pm 8$  kV using the IEC 61000-4-2 Contact Discharge method, and  $\pm 15$  kV using the Human-Body Model (HBM).

The device operates at a data rate of 460 kbps. The transceiver has a proprietary low-dropout driver output stage, enabling RS-232-compatible operation from a 2.25-V to 3-V supply with a dual charge pump. The charge pump requires only four 0.1- $\mu$ F capacitors and features a logic-level output (READY) that asserts when the charge pump is regulating and the device is ready to begin transmitting.

The TRS3318E achieves a 1- $\mu$ A supply current using the auto-powerdown feature. This device automatically enters a low-power power-down mode when the RS-232 cable is disconnected or the drivers of the connected peripherals are inactive for more than 30 s. The device turns on again when it senses a valid transition at any driver or receiver input. Auto-powerdown saves power without changes to the existing BIOS or operating system.

This device is available in two space-saving packages: 20-pin SSOP and 20-pin TSSOP.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

**TRS3318E**  
**2.5-V 460-kbps RS-232 TRANSCEIVER**  
**WITH  $\pm 15$ -kV ESD PROTECTION**

SLLS805 – APRIL 2007

**ORDERING INFORMATION**

T <sub>A</sub>	PACKAGE <sup>(1)(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	SSOP – DB	Tube of 70	TRS3318ECDB	RV318EC
		Reel of 2000	TRS3318ECDBR	
	TSSOP – PW	Tube of 70	TRS3318ECPW	RV318EC
		Reel of 2000	TRS3318ECPWR	
–40°C to 85°C	SSOP – DB	Tube of 70	TRS3318EIDB	RV318EI
		Reel of 2000	TRS3318EIDBR	
	TSSOP – PW	Tube of 70	TRS3318EIPW	RV318EI
		Reel of 2000	TRS3318EIPWR	

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at [www.ti.com](http://www.ti.com).

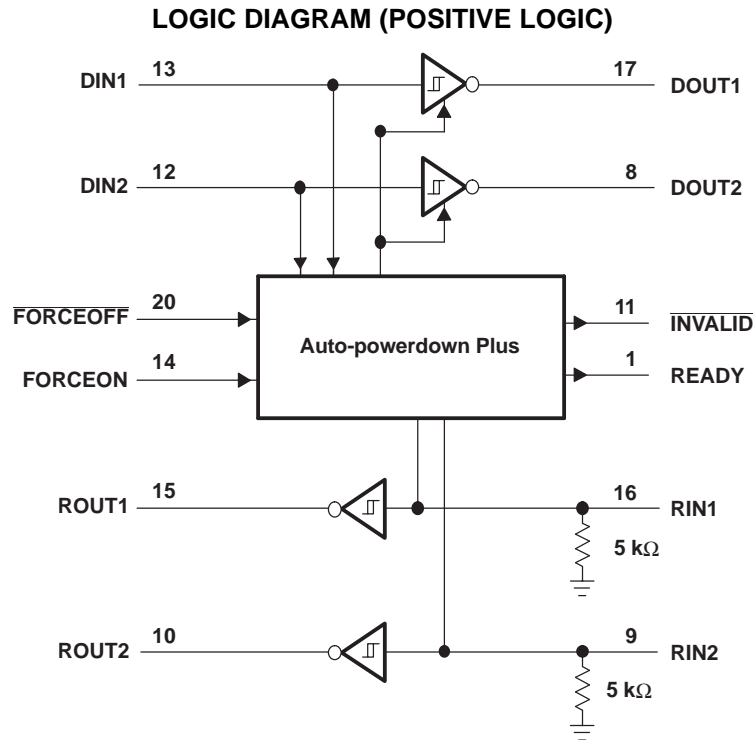
**DETAILED DESCRIPTION**

Flexible control options for power management are featured when the serial port and driver inputs are inactive. The auto-powerdown plus feature functions when FORCEON is low and  $\overline{\text{FORCEOFF}}$  is high. During this mode of operation, if the device does not sense valid signal transitions on all receiver and driver inputs for approximately 30 s, the built-in charge pump and drivers are powered down, reducing the supply current to 1  $\mu\text{A}$ . By disconnecting the serial port or placing the peripheral drivers off, auto-powerdown plus can be disabled when FORCEON and  $\overline{\text{FORCEOFF}}$  are high. With auto-powerdown plus enabled, the device activates automatically when a valid signal is applied to any receiver or driver input.  $\overline{\text{INVALID}}$  is high (valid data) if any receiver input voltage is greater than 2.7 V or less than –2.7 V, or has been between –0.3 V and 0.3 V for less than 30  $\mu\text{s}$  (typical number).  $\overline{\text{INVALID}}$  is low (invalid data) if all receiver input voltage are between –0.3 V and 0.3 V for more than 30  $\mu\text{s}$  (typical number).

**FUNCTION TABLE<sup>(1)</sup>**

INPUT CONDITIONS				OUTPUT STATES				OPERATING MODE
FORCEON	$\overline{\text{FORCEOFF}}$	RECEIVER OR DRIVER EDGE WITHIN 30 s	VALID RS-232 LEVEL PRESENT AT RECEIVER	DRIVER	RECEIVER	$\overline{\text{INVALID}}$	READY	
<b>Auto-Powerdown Plus Conditions</b>								
H	H	No	No	Active	Active	L	H	Normal operation, auto-powerdown plus disabled
H	H	No	Yes	Active	Active	H	H	Normal operation, auto-powerdown plus disabled
L	H	Yes	No	Active	Active	L	H	Normal operation, auto-powerdown plus enabled
L	H	Yes	Yes	Active	Active	H	H	Normal operation, auto-powerdown plus enabled
L	H	No	No	Z	Active	L	L	Power down, auto-powerdown plus enabled
L	H	No	Yes	Z	Active	H	L	Power down, auto-powerdown plus enabled
X	L	X	No	Z	Active	L	L	Manual power down
X	L	X	Yes	Z	Active	H	L	Manual power down
<b>Auto-Powerdown Conditions</b>								
$\overline{\text{INVALID}}$	$\overline{\text{INVALID}}$	X	No	Z	Active	L	L	Power down, auto-powerdown enabled
$\overline{\text{INVALID}}$	$\overline{\text{INVALID}}$	X	Yes	Active	Active	H	H	Normal operation, auto-powerdown enabled

(1) H = high level, L = low level, X = irrelevant, Z = high impedance



**TERMINAL FUNCTIONS**

TERMINAL		DESCRIPTION
NAME	NO.	
C1+	2	Positive voltage-doubler charge-pump capacitor
C1–	4	Negative voltage-doubler charge-pump capacitor
C2+	5	Positive inverting charge-pump capacitor
C2–	6	Negative inverting charge-pump capacitor
DIN	12, 13	CMOS driver inputs
DOUT	8, 17	RS-232 driver outputs
FORCEOFF	20	Force-off input, active low. Drive low to power down transmitters, receivers, and charge pump. This overrides auto-powerdown and FORCEON (see Function Table).
FORCEON	14	Force-on input, active high. Drive high to override auto-powerdown, keeping transmitters and receivers on (FORCEOFF must be high) (see Function Table).
GND	18	Ground
INVALID	11	Valid signal detector output, active low. A logic high indicates that a valid RS-232 level is present on a receiver input.
READY	1	Ready to transmit output, active high. READY is enabled high when V– goes below –3.5 V and the device is ready to transmit.
RIN	9, 16	RS-232 receiver inputs
ROUT	10, 15	CMOS receiver outputs
V+	3	$2 \times V_{CC}$ generated by the charge pump
V–	7	$-2 \times V_{CC}$ generated by the charge pump
V <sub>CC</sub>	19	2.25-V to 3-V single-supply voltage

### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>CC</sub> to GND		-0.3	6	V
V+ to GND <sup>(2)</sup>		-0.3	7	V
V- to GND <sup>(2)</sup>		-7	0.3	V
V+ +  V-  <sup>(2)</sup>			13	V
Input voltage	DIN, FORCEON, FORCEOFF to GND	-0.3	6	V
	RIN to GND		$\pm 25$	
Output voltage	DOUT to GND		$\pm 13.2$	V
	ROUT, INVALID, READY to GND	-0.3	V <sub>CC</sub> + 0.3	
Short-circuit duration	DOUT to GND		Continuous	
Continuous power dissipation (T <sub>A</sub> = 70°C)	20-pin SSOP (derate 8 mW/°C above 70°C)		640	mW
	20-pin TSSOP (derate 7 mW/°C above 70°C)		559	
Storage temperature range		-65	150	°C
Lead temperature (soldering, 10 s)			300	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) V+ and V- can have maximum magnitudes of 7 V, but their absolute difference cannot exceed 13 V.

### Recommended Operating Conditions

See Figure 4

			MIN	NOM	MAX	UNIT
Supply voltage			2.25	2.5	3	V
V <sub>IH</sub>	Driver and control high-level input voltage	DIN, FORCEOFF, FORCEON V <sub>CC</sub> = 2.5 V to 3 V	0.7 × V <sub>CC</sub>		5.5	V
V <sub>IL</sub>	Driver and control low-level input voltage	DIN, FORCEOFF, FORCEON V <sub>CC</sub> = 2.5 V to 3 V	0	0.3 × V <sub>CC</sub>		V
V <sub>I</sub>	Receiver input voltage		-25	25		V
T <sub>A</sub>	Operating free-air temperature	TRS3318EC	0		70	°C
		TRS3318EI	-40		85	

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## Supply Current Section

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25\text{ V to }3\text{ V}$ ,  $C1\text{--}C4 = 0.1\ \mu\text{F}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
<b>DC Characteristics (<math>V_{CC} = 2.5\text{ V}</math>, <math>T_A = 25^\circ\text{C}</math>)</b>					
Auto-powerdown plus supply current	$\overline{\text{FORCEON}} = \text{GND}$ , $\overline{\text{FORCEOFF}} = V_{CC}$ , All RIN and DIN idle		1	10	$\mu\text{A}$
Auto-powerdown supply current	$\overline{\text{FORCEOFF}} = \text{GND}$		1	10	$\mu\text{A}$
Supply current	$\overline{\text{FORCEON}} = \overline{\text{FORCEOFF}} = V_{CC}$ , No load		0.3	2	mA

(1) Typical values are at  $V_{CC} = 2.5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

### ESD Protection

PARAMETER	TEST CONDITIONS	TYP	UNIT
RIN, DOUT	HBM	$\pm 15$	kV
	IEC 61000-4-2 Air-Gap Discharge method	$\pm 15$	
	IEC 61000-4-2 Contact Discharge method	$\pm 8$	

## Driver Section

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25\text{ V to }3\text{ V}$ ,  $C1\text{--}C4 = 0.1\ \mu\text{F}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted) (see [Figure 4](#))

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
Driver input hysteresis			0.3		V
Input leakage current	FORCEON, DIN, FORCEOFF		$\pm 0.01$	$\pm 1$	$\mu\text{A}$
Output voltage swing	All driver outputs loaded with 3 k $\Omega$ to ground	$\pm 3.7$	$\pm 4$		V
Output resistance	$V_{CC} = 0$ , Driver output = $\pm 2\text{ V}$	300	10M		$\Omega$
Output short-circuit current <sup>(2)</sup>			$\pm 25$	$\pm 60$	mA
Output leakage current	$V_{CC} = 0$ or 2.25 V to 3 V, $V_{OUT} = \pm 12\text{ V}$ , Drivers disabled			$\pm 25$	$\mu\text{A}$

(1) Typical values are at  $V_{CC} = 2.5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

(2) Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25\text{ V to }3\text{ V}$ ,  $C1\text{--}C4 = 0.1\ \mu\text{F}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted) (see [Figure 1](#))

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
Maximum data rate	$R_L = 3\text{ k}\Omega$ , $C_L = 1000\text{ pF}$ , One transmitter switching	460			kbps
$ t_{PHL} - t_{PLH} $ Driver skew <sup>(2)</sup>			100		ns
Transition-region slew rate	$V_{CC} = 2.5\text{ V}$ , $T_A = 25^\circ\text{C}$ , $R_L = 3\text{ k}\Omega$ to 7 k $\Omega$ , Measured from 3 V to $-3\text{ V}$ or $-3\text{ V}$ to 3 V, $C_L = 150\text{ pF}$ to 2500 pF	4		30	V/ $\mu\text{s}$

(1) Typical values are at  $V_{CC} = 2.5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

(2) Pulse skew is defined as  $|t_{PLH} - t_{PHL}|$  of each channel of the same device.

## Receiver Section

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25$  V to 3 V, C1–C4 = 0.1  $\mu$ F,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted) (see [Figure 4](#))

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
Input voltage range		-25		25	V
Input threshold low	$T_A = 25^\circ\text{C}$			$0.3 \times V_{CC}$	V
Input threshold high	$T_A = 25^\circ\text{C}$	$0.7 \times V_{CC}$			V
Input hysteresis			0.3		V
Input resistance	$T_A = 25^\circ\text{C}$	3	5	7	k $\Omega$
Output leakage current			$\pm 0.05$	$\pm 10$	$\mu$ A
Output voltage low	$I_{OUT} = 0.5$ mA			$0.1 \times V_{CC}$	V
Output voltage high	$I_{OUT} = -0.5$ mA	$0.9 \times V_{CC}$			V

(1) Typical values are at  $V_{CC} = 2.5$  V,  $T_A = 25^\circ\text{C}$ .

### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25$  V to 3 V, C1–C4 = 0.1  $\mu$ F (unless otherwise noted) (see [Figure 4](#))

PARAMETER	TEST CONDITIONS	TYP <sup>(1)</sup>	UNIT
$t_{PHL}$	Receiver propagation delay RIN to ROUT, $C_L = 150$ pF	0.175	$\mu$ s
$t_{PLH}$		0.175	
$ t_{PHL} - t_{PLH} $	Receiver skew <sup>(2)</sup>	50	ns

(1) Typical values are at  $V_{CC} = 2.5$  V,  $T_A = 25^\circ\text{C}$ .

(2) Pulse skew is defined as  $|t_{PLH} - t_{PHL}|$  of each channel of the same device.



## Auto-Powerdown Plus Section

### Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25\text{ V to }3\text{ V}$ ,  $C1\text{--}C4 = 0.1\ \mu\text{F}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted) (see [Figure 4](#))

PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
Receiver input threshold to $\overline{\text{INVALID}}$ high	Positive threshold		2.7	V
	Negative threshold	-2.7		
Receiver input threshold $\overline{\text{INVALID}}$ low		-0.3	0.3	V
$\overline{\text{INVALID}}$ , READY voltage low	$I_{OUT} = 0.5\text{ mA}$		$0.1 \times V_{CC}$	V
$\overline{\text{INVALID}}$ , READY voltage high	$I_{OUT} = -0.5\text{ mA}$	$0.8 \times V_{CC}$		V

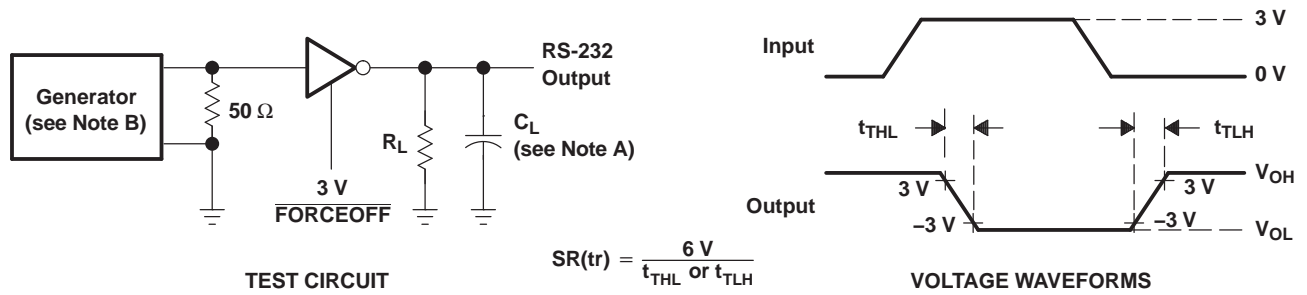
### Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature,  
 $V_{CC} = 2.25\text{ V to }3\text{ V}$ ,  $C1\text{--}C4 = 0.1\ \mu\text{F}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$  (unless otherwise noted) (see [Figure 4](#))

PARAMETER	TEST CONDITIONS	MIN	TYP <sup>(1)</sup>	MAX	UNIT
$t_{INVH}$ Receiver positive or negative threshold to $\overline{\text{INVALID}}$ high	$V_{CC} = 2.5\text{ V}$		1		$\mu\text{s}$
$t_{INVL}$ Receiver positive or negative threshold to $\overline{\text{INVALID}}$ low	$V_{CC} = 2.5\text{ V}$		30		$\mu\text{s}$
$t_{WU}$ Receiver or driver edge to driver enabled	$V_{CC} = 2.5\text{ V}$		100		$\mu\text{s}$
$t_{AUTOPRDN}$ Receiver or driver edge to driver shutdown	$V_{CC} = 2.5\text{ V}$	15	30	60	s

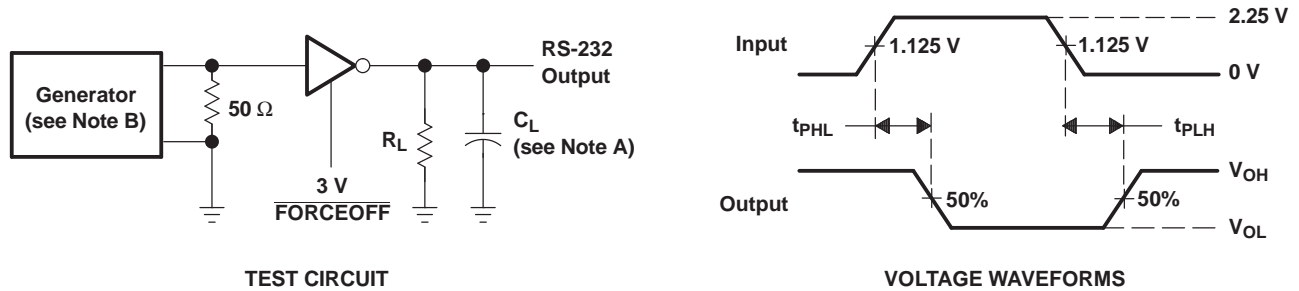
(1) Typical values are at  $V_{CC} = 2.5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

**PARAMETER MEASUREMENT INFORMATION**



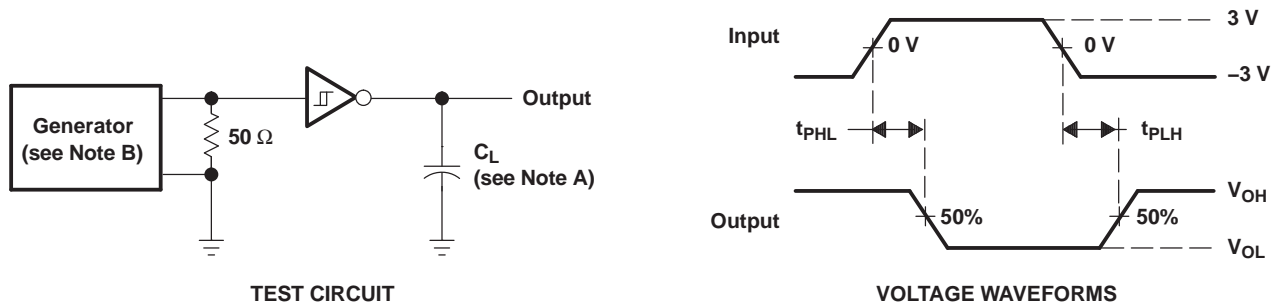
NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_0 = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

**Figure 1. Driver Slew Rate**



NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_0 = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

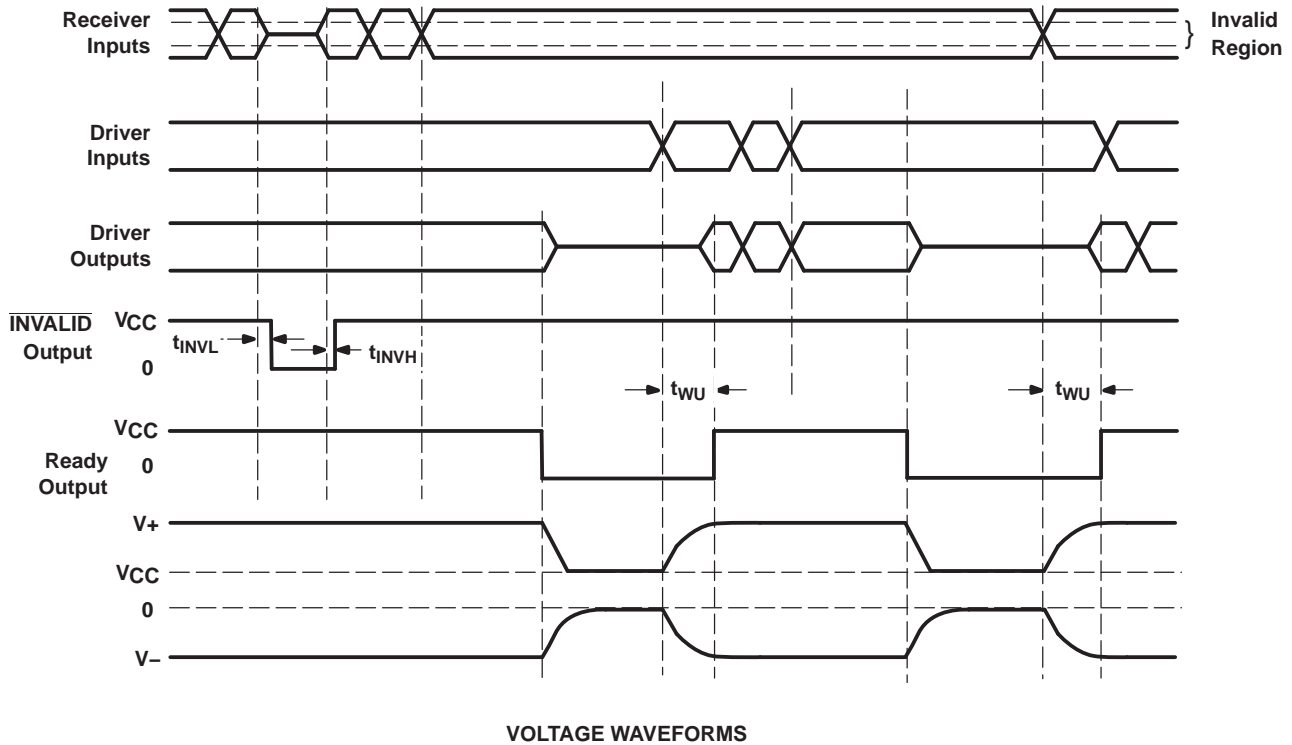
**Figure 2. Driver Pulse Skew**



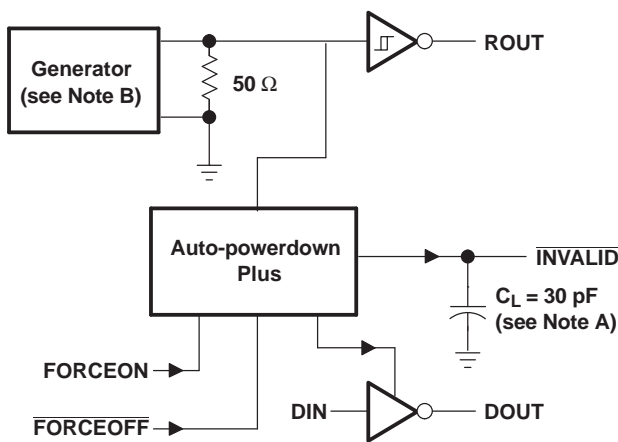
NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics:  $Z_0 = 50\ \Omega$ , 50% duty cycle,  $t_r \leq 10\text{ ns}$ ,  $t_f \leq 10\text{ ns}$ .

**Figure 3. Receiver Propagation Delay Times**

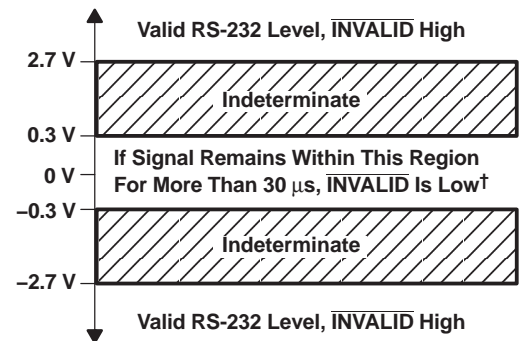
PARAMETER MEASUREMENT INFORMATION (continued)



VOLTAGE WAVEFORMS



TEST CIRCUIT



† Auto-powerdown disables drivers and reduces supply current to 1  $\mu$ A.

Figure 4.  $\overline{\text{INVALID}}$  Propagation Delay Times and Supply Enabling Time

APPLICATION INFORMATION

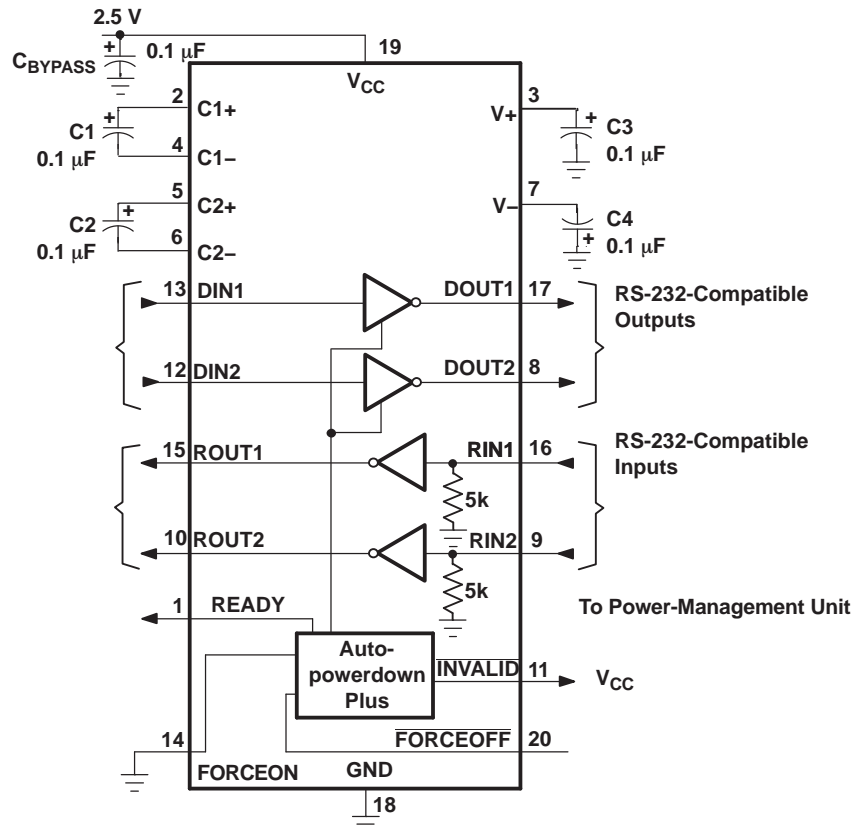


Figure 5. Typical Application Circuit

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TRS3318ECDB	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBG4	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECDBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318ECPWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDB	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBG4	ACTIVE	SSOP	DB	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIDBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPW	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWG4	ACTIVE	TSSOP	PW	20	70	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWR	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TRS3318EIPWRG4	ACTIVE	TSSOP	PW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

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**TAPE AND REEL INFORMATION**



**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TRS3318ECDBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
TRS3318ECPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1
TRS3318EIDBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
TRS3318EIPWR	TSSOP	PW	20	2000	330.0	16.4	6.95	7.1	1.6	8.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TRS3318ECDBR	SSOP	DB	20	2000	346.0	346.0	33.0
TRS3318ECPWR	TSSOP	PW	20	2000	346.0	346.0	33.0
TRS3318EIDBR	SSOP	DB	20	2000	346.0	346.0	33.0
TRS3318EIPWR	TSSOP	PW	20	2000	346.0	346.0	33.0



PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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